MOSFET – Small Signal, Complementary with ESD Protection, SOT-563

20 V, 540 mA / -430 mA

Features

- Leading Trench Technology for Low RDS(on) Performance
- High Efficiency System Performance
- Low Threshold Voltage
- ESD Protected Gate
- Small Footprint 1.6 x 1.6 mm
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- DC-DC Conversion Circuits
- Load/Power Switching with Level Shift
- Single or Dual Cell Li-Ion Battery Operated Systems
- High Speed Circuits
- Cell Phones, MP3s, Digital Cameras, and PDAs

MAXIMUM RATINGS (T, I = 25°C unless otherwise specified)

| Para | Symbol | Value | Unit | | | |
|---|------------------------|---------------------------------------|-----------------|------|------|--|
| Drain-to-Source Voltaç | V_{DSS} | 20 | V | | | |
| Gate-to-Source Voltag | Gate-to-Source Voltage | | | | | |
| N-Channel Continu- | Steady | $T_A = 25^{\circ}C$ | | 540 | | |
| ous Drain Current (Note 1) | State | T _A = 85°C | | 390 | | |
| | t ≤ 5 s | T _A = 25°C | | 570 | m ^ | |
| P-Channel Continu- | Steady | T _A = 25°C | I _D | -430 | mA | |
| ous Drain Current (Note 1) | State | T _A = 85°C | | -310 | | |
| | t ≤ 5 s | T _A = 25°C | | -455 | | |
| Power Dissipation | Steady | Steady State T _A = 25°C | P _D | 250 | | |
| (Note 1) | State | | | | mW | |
| | t ≤ 5 s | | | 280 | | |
| Pulsed Drain Current | N-Channel | t = 10 us | 1 | 1500 | mA | |
| | P-Channel | t _p = 10 μs | I _{DM} | -750 | IIIA | |
| Operating Junction and | T _J , | -55 to | °C | | | |
| | T _{STG} | 150 | | | | |
| Source Current (Body [| I _S | 350 | mA | | | |
| Lead Temperature for S (1/8" from case for 1 | TL | 260 | °C | | | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using 1 in sq. pad size (Cu area = 1.127 in sq [1 oz] including traces).

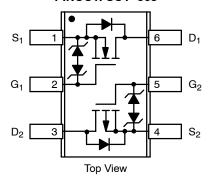


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| V _{(BR)DSS} | R _{DS(on)} Typ | I _D Max (Note 1) |
|----------------------|-------------------------|--------------------------------|
| | 0.4 Ω @ 4.5 V | |
| N-Channel 20 V | 0.5 Ω @ 2.5 V | 540 mA |
| 20 • | 0.7 Ω @ 1.8 V | |
| 2 | 0.5 Ω @ -4.5 V | |
| P-Channel -20 V | 0.6 Ω @ -2.5 V | –430 mA |
| _5 • | 1.0 Ω @ -1.8 V | |

PINOUT: SOT-563





TW = Specific Device Code

M = Date Code ■ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping [†] | |
|--------------|-----------|-----------------------|--|
| NTZD3155CT1G | | 4000 / Tana 9 Dag | |
| NTZD3155CT2G | SOT-563 | 4000 / Tape & Reel | |
| NTZD3155CT5G | (Pb-Free) | 8000 / Tape & Reel | |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Thermal Resistance Ratings

| Parameter | Symbol | Max | Unit |
|---|----------------|-----|------|
| Junction-to-Ambient - Steady State (Note 2) | $R_{	heta JA}$ | 500 | °C/W |
| Junction-to-Ambient - t = 5 s (Note 2) | | 447 | |

^{2.} Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

ELECTRICAL CHARACTERISTICS (T₁ = 25°C unless otherwise specified)

| Parameter | Symbol | N/P | Test Condition | | Min | Тур | Max | Unit |
|--|--------------------------------------|-----|--|--------------------------|-------|------|------|--------|
| OFF CHARACTERISTICS | | | | | | | - | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | N | V _{GS} = 0 V | I _D = 250 μA | 20 | | | V |
| | | Р | | I _D = -250 μA | -20 | | | |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V(_{BR)DSS} /T _J | | | | | 18 | | mV/°C |
| Zero Gate Voltage Drain Current | I _{DSS} | N | V _{GS} = 0 V, V _{DS} = 16 V | T _J = 25°C | | | 1.0 | μΑ |
| | | Р | $V_{GS} = 0 \text{ V}, V_{DS} = -16 \text{ V}$ | | | | -1.0 | |
| | | N | V _{GS} = 0 V, V _{DS} = 16 V | T _J = 125°C | | | 2.0 | μΑ |
| | | Р | V _{GS} = 0 V, V _{DS} = - 16V | 1 | | | -5.0 | |
| Gate-to-Source Leakage Current | I _{GSS} | Р | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$ | | | | ±2.0 | μΑ |
| | | N | | | | | ±5.0 | |
| ON CHARACTERISTICS (Note 3) | | | | | | | - | |
| Gate Threshold Voltage | V _{GS(TH)} | N | $V_{GS} = V_{DS}$ | I _D = 250 μA | 0.45 | | 1.0 | V |
| | | Р | | I _D = -250 μA | -0.45 | | -1.0 | |
| Gate Threshold Temperature Coefficient | V _{GS(TH)} /T _J | | | | | -1.9 | | -mV/°C |
| Drain-to-Source On Resistance | R _{DS(on)} | N | V_{GS} = 4.5 V, I_{D} = 540 mA V_{GS} = -4.5 V, I_{D} = -430 mA V_{GS} = 2.5 V, I_{D} = 500 mA | | | 0.4 | 0.55 | |
| | | Р | | | | 0.5 | 0.9 | |
| | | N | | | | 0.5 | 0.7 | |
| | | Р | $V_{GS} = -2.5V, I_D = -2.5V$ | -300 mA | | 0.6 | 1.2 | Ω |
| | | N | V _{GS} = 1.8 V, I _D = 3 | 350 mA | | 0.7 | 0.9 | |
| | | Р | $V_{GS} = -1.8V, I_D = -1.8V$ | -150 mA | | 1.0 | 2.0 | |
| Forward Transconductance | 9 _{FS} | N | V _{DS} = 10 V, I _D = 5 | 540 mA | | 1.0 | | |
| | | Р | V _{DS} = -10 V, I _D = -430 mA | | | 1.0 | | S |
| CHARGES, CAPACITANCES AND GA | ATE RESISTAN | ICE | | | | | | |
| Input Capacitance | C _{ISS} | | | | | 80 | 150 | |
| Output Capacitance | C _{OSS} | N | f = 1 MHz, V _{GS} V _{DS} = 16 V | = 0 V / | | 13 | 25 | 1 |
| Reverse Transfer Capacitance | C _{RSS} | 1 | VDS - 10 V | | | 10 | 20 | . – |
| Input Capacitance | C _{ISS} | | | | | 105 | 175 | pF |
| Output Capacitance | C _{OSS} | Р | $f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$ $V_{DS} = -16 \text{ V}$ | | | 15 | 30 | |
| Reverse Transfer Capacitance | C _{RSS} | 1 | | | | 10 | 20 | |

^{3.} Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

| | Symbol | N/P | Test Condition | on | Min | Тур | Max | Unit |
|---------------------------------|----------------------------|------|---|---------------------------|-----|------|------|------|
| CHARGES, CAPACITANCES AND | GATE RESIST | ANCE | 1 | | | | | |
| Total Gate Charge | Q _{G(TOT)} | | N $V_{GS} = 4.5 \text{ V}, V_{DS} = -10 \text{ V}; I_D = 540 \text{ mA}$ | | | 1.5 | 2.5 | |
| Threshold Gate Charge | Q _{G(TH)} | N | | | | 0.1 | | |
| Gate-to-Source Charge | Q_{GS} | 1 | | | | 0.2 | | |
| Gate-to-Drain Charge | Q_{GD} | 1 | | | | 0.35 | | 0 |
| Total Gate Charge | Q _{G(TOT)} | | $V_{GS} = -4.5 \text{ V}, V_{DS} = 10 \text{ V}; I_{D} = -380 \text{ mA}$ | | | 1.7 | 2.5 | nC |
| Threshold Gate Charge | Q _{G(TH)} | P | | | | 0.1 | | |
| Gate-to-Source Charge | Q_{GS} | 7 | | | | 0.3 | | |
| Gate-to-Drain Charge | Q_{GD} | | | | | 0.4 | | |
| SWITCHING CHARACTERISTICS | (V _{GS} = V) (Not | e 4) | | | | | | |
| Turn-On Delay Time | t _{d(ON)} | N | V_{GS} = 4.5 V, V_{DD} = -10 V, I_{D} = 540 mA, R_{G} = 10 Ω | | | 6.0 | | |
| Rise Time | t _r | | | | | 4.0 | | |
| Turn-Off Delay Time | t _{d(OFF)} | 1 | | | | 16 | | |
| Fall Time | t _f | 1 | | | | 8.0 | | |
| Turn-On Delay Time | t _{d(ON)} | Р | | | | 10 | | ns |
| Rise Time | t _r | 1 | V _{GS} = -4.5 V, V _{DD} = 10 V, | I _D = -215 mA, | | 12 | | |
| Turn-Off Delay Time | t _{d(OFF)} | 1 | $R_G = 10 \Omega$ | | | 35 | | |
| Fall Time | t _f | | | | | 19 | | |
| Drain-Source Diode Characterist | tics | | | | | | | |
| Forward Diode Voltage | V _{SD} | N | V 0V T 050C | I _S = 350 mA | | 0.7 | 1.2 | \/ |
| | | Р | $V_{GS} = 0 \text{ V, T}_{J} = 25^{\circ}\text{C}$ | $I_{S} = -350 \text{ mA}$ | | -0.8 | -1.2 | V |
| Reverse Recovery Time | t _{RR} | N | $V_{GS} = 0 V$, | I _S = 350 mA | | 6.5 | | |
| | | Р | dIS/dt = 100 A/μs | $I_{S} = -350 \text{ mA}$ | | 13 | | ns |

^{4.} Switching characteristics are independent of operating junction temperatures

N-CHANNEL TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

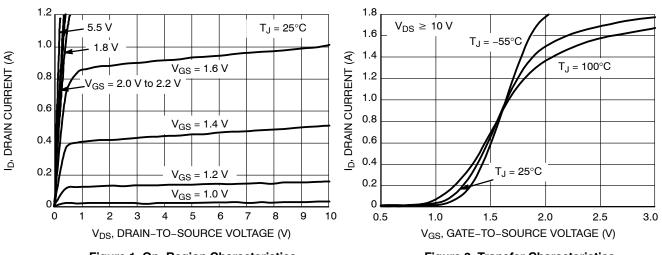


Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics

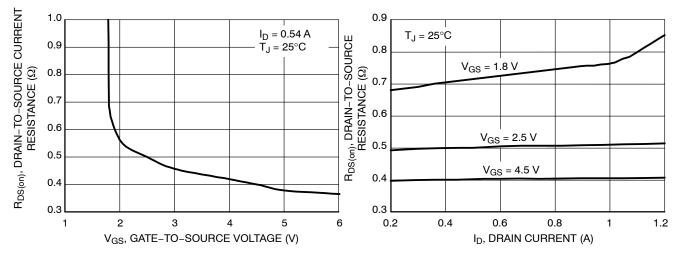


Figure 3. On-Resistance versus Gate-to-Source Voltage

Figure 4. On-Resistance versus Drain Current and Gate Voltage

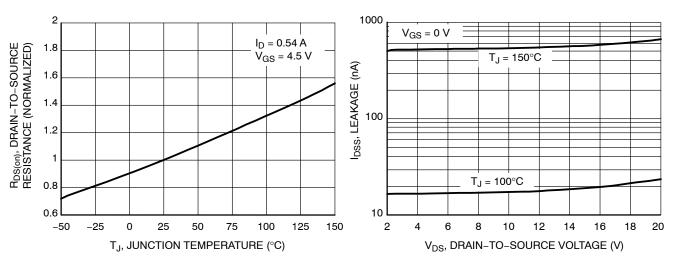


Figure 5. On–Resistance Variation with Temperature

Figure 6. Drain-to-Source Leakage Current versus Voltage

N-CHANNEL TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

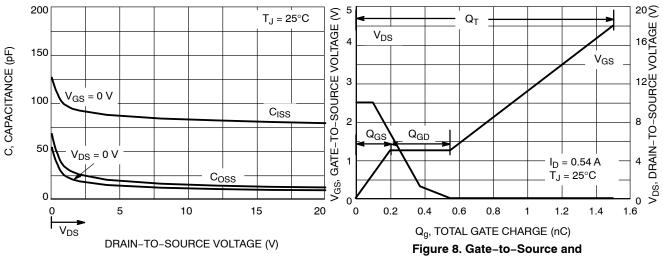


Figure 7. Capacitance Variation

Drain-to-Source Voltage versus Total Charge

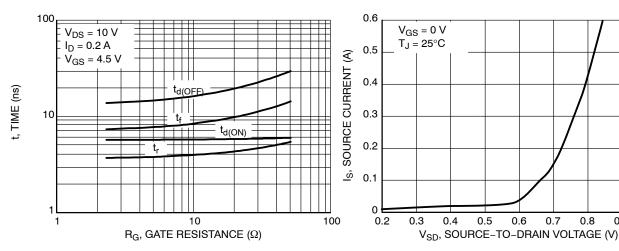


Figure 9. Resistive Switching Time Variation versus Gate Resistance

Figure 10. Diode Forward Voltage versus Current

0.7

0.8

P-CHANNEL TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

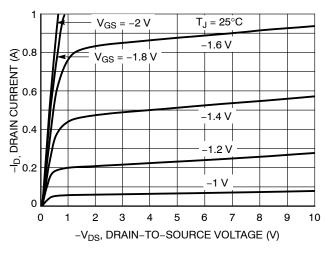


Figure 1. On-Region Characteristics

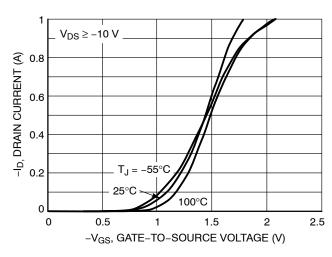


Figure 2. Transfer Characteristics

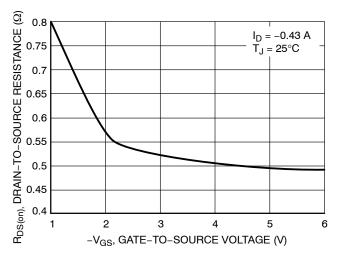


Figure 3. On-Resistance vs. Gate-to-Source Voltage

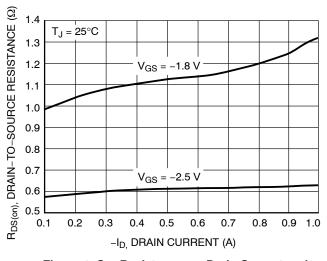


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

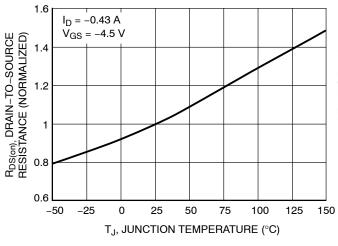


Figure 5. On–Resistance Variation with Temperature

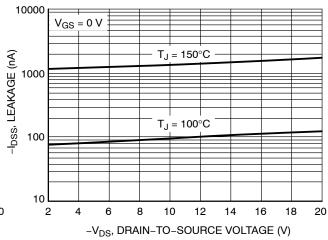


Figure 6. Drain-to-Source Leakage Current vs. Voltage

P-CHANNEL TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

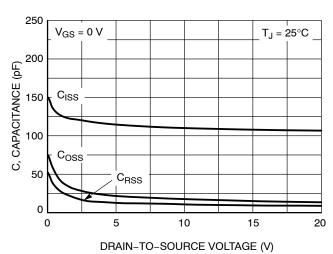
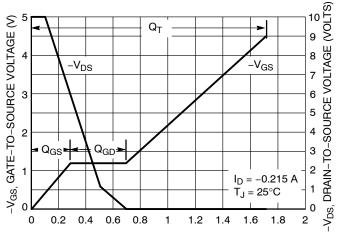


Figure 7. Capacitance Variation



Q_G, TOTAL GATE CHARGE (nC)

Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

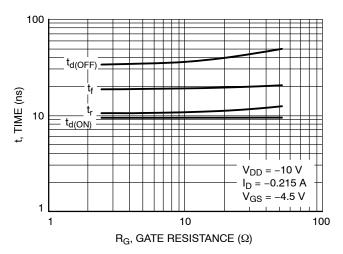


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

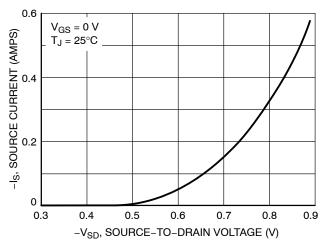


Figure 10. Diode Forward Voltage vs. Current

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



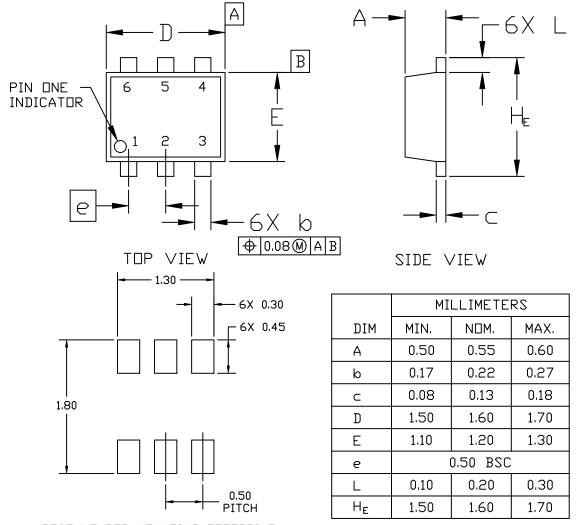


SOT-563, 6 LEAD CASE 463A ISSUE H

DATE 26 JAN 2021

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.



RECOMMENDED MOUNTING FOOTPRINT*

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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SOT-563, 6 LEAD

CASE 463A ISSUE H

2

1

DATE 26 JAN 2021

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GENERIC MARKING DIAGRAM*



XX = Specific Device CodeM = Month Code= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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